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MAIL STOP AF
PATENT
8026-1004



IN THE U.S. PATENT AND TRADEMARK OFFICE

In re application of:

Koki HIRASAWA et al.

Conf. 2347

Appl. No. 09/923,394

Group 2826

Filed August 8, 2001

Examiner F. Erdem

LEAD FRAME, SEMICONDUCTOR DEVICE
PRODUCED BY USING THE SAME AND
METHOD OF PRODUCING THE SEMICONDUCTOR
DEVICE

REQUEST FOR RECONSIDERATION

Mail Stop AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

December 13, 2006

Sir:

In response to the Official Action mailed September 21,
2006, please amend the above-identified application as follows:

A Listing of the Claims begins on page 2 of this paper.

Remarks begin on page 11 of this paper.

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AMENDMENT AFTER FINAL REJECTION

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

March 17, 2005

Sir:

In response to the Official Action mailed December 3,
2004, please amend the above-identified application as follows:

Amendments to the Claims are reflected in the listing
of claims which begins on page 2 of this paper.

Remarks begin on page 9 of this paper.

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